swissbit®

Product Fact Sheet

Industrial / Automotive e•MMC Memory

EM-30 Series

JEDEC e•MMC 5.1 compliant, BGA 153 ball AEC – Q100 Grade 2

Industrial / Automotive Temperature Grade

Date: June 7, 2023 Revision: 1.05



Made in Germany

Product Fact Sheet EM-30 Series

Product Summary

- Capacities: 4 GBytes, 8 GBytes, 16 GBytes, 32 GBytes, 64 GBytes, 128 GBytes, 256 GBytes
- Operating Temperature Range¹:
 - Industrial Operating Temperature -40 to 85°C
 - Automotive Operating Temperature -40 to 105°C
 ATS 2 Products² (Assembly Test Site 2): AEC Q100 Grade 2 certified, except 4 GBytes 8 GBytes and 16 GBytes
- Endurance in TeraBytes Written (TBW) @ Max Capacity³: up to 250

Product Features

- Fully compliant with JEDEC e•MMC 5.1 Standard (JESD84-B51)
- 153-ball BGA, 0.5mm pitch
- 11.5 x 13mm, RoHS compliant
- 3D TLC NAND base technology
- Multiple 3D TLC or enhanced/reliable mode partitions user configurable according to e•MMC Spec 5.1
- High performance e•MMC 5.1 specification
 - o Eleven-wire bus (clock, data strobe, 1 bit command, 8 bit data bus) and a hardware reset
 - Three different data bus width modes: 1-bit (default), 4-bit, and 8-bit
 - Clock frequencies o-200MHz, High Speed Mode HS400
 - Command Queue Feature according to e•MMC Spec 5.1
 - Up to 300MB/s sequential read and up to 230MB/s sequential write
- Power Supply: (Low-power CMOS technology)
 - VCCQ 1.7V...1.95V or 2.7V...3.6V e•MMC supply
 - VCC 2.7V...3.6V NAND Flash supply
- Optimized FW algorithms
 - Power-fail data loss protection
 - Wear Leveling technology
 Equal wear leveling of static and dynamic data. The wear leveling assures that dynamic data as well as static data is balanced evenly across the memory. With that the maximum write endurance of the device is ensured
 - Read Disturb Management
 The read commands per region are monitored and the content is conditionally refreshed when critical levels have occurred
 - Auto Read Refresh
 The interruptible background process maintains the user data for Read Disturb effects or Retention degradation due to high temperature effects
 - Diagnostic features with Device Health Report according to e•MMC Spec 5.1, and detailed Lifetime Monitor data (Swissbit proprietary, accessible through standard e•MMC commands).
 - Field Firmware update⁴s according to e•MMC Spec 5.1
 - Discard and Sanitize, Trim
 - Boot Operation Mode and Alternative Boot Operation Mode
 - Replay Protected Memory Block (RPMB)

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¹ Adequate airflow is required to ensure the temperature does not exceed 85°C (industrial temperature drive) or 105°C (automotive temperature drive)

² See Table 1: Available Part Numbers

³ According to JEDEC (JESD471), the time to write the full TBW is a minimum of 18 months. Higher average daily data volume reduces the specified TBW. The values listed are estimates and are subject to change without notice.

⁴ The support of In-Field FW update capabilities on host systems is recommended. Swissbit AG

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- High reliability
 - Designed with sophisticated firmware architecture for industrial and embedded markets.
 - Ideal for application like POS/POI, PLC, IoT, gaming, medical and use as general boot medium for embedded applications.
 - The product is optimized for long life cycle that requires superior data retention as well as power fail safety.
 - o Intensive write applications should use the enhanced/reliable mode
 - Controlled BOM & PCN process

1 Order Information for EM-30

Table 1: Available Part Numbers

ATS 1 Gen3 Flash			
	Temperature		
Capacity	Industrial (–40 to 85°C)	Automotive (-40 to 105°C)	
	Part Number	Part Number	
16 GBytes	SFEM016GB1ED1T0-I-5E-111-STD	-	
32 GBytes	SFEM032GB1ED1T0-I-5E-111-STD	SFEM032GB1ED1T0-A-5E-111-STD	
64 GBytes	SFEM064GB1ED1T0-I-6F-111-STD	SFEM064GB1ED1T0-A-6F-111-STD	
128 GBytes	SFEM128GB1ED1T0-I-7G-111-STD	SFEM128GB1ED1TO-A-7G-111-STD	
256 GBytes	SFEM256GB1ED1T0-I-8H-111-STD	SFEM256GB1ED1T0-A-8H-111-STD	

ATS 1 (Assembly Test Site 1)

Table 2: Available Part Numbers

ATS 2 Gen3 Flash			
Temperature			
Industrial (–40 to 85°C)	Automotive (-40 to 105°C)		
Part Number	Part Number		
SFEM004GB2ED1T0-I-5E-111-STD	-		
SFEM008GB2ED1T0-I-5E-111-STD	-		
SFEM016GB2ED1T0-I-5E-111-STD	-		
SFEM032GB2ED1T0-I-5E-111-STD	SFEM032GB2ED1T0-A-5E-111-STD		
SFEM064GB2ED1T0-I-6F-111-STD	SFEM064GB2ED1T0-A-6F-111-STD		
SFEM128GB2ED1T0-I-7G-111-STD	SFEM128GB2ED1T0-A-7G-111-STD		
	Temp Industrial (-40 to 85°C) Part Number SFEM004GB2ED1T0-I-5E-111-STD SFEM008GB2ED1T0-I-5E-111-STD SFEM016GB2ED1T0-I-5E-111-STD SFEM016GB2ED1T0-I-5E-111-STD SFEM032GB2ED1T0-I-5E-111-STD SFEM032GB2ED1T0-I-5E-111-STD SFEM032GB2ED1T0-I-5E-111-STD SFEM064GB2ED1T0-I-6F-111-STD		

ATS 2 (Assembly Test Site 2)

Table 3: Available Part Numbers

ATS 2 Gen5 Flash				
	Temperature			
Capacity	Capacity Industrial (–40 to 85°C) Automotive (–40 to 105°C)			
	Part Number	Part Number		
64 GBytes	SFEM064GB2ED1TB-I-CE-111-STD	SFEM064GB2ED1TB-A-CE-111-STD		
128 GBytes	SFEM128GB2ED1TB-I-EF-111-STD	SFEM128GB2ED1TB-A-EF-111-STD		
256 GBytes	SFEM256GB2ED1TB-I-VG-111-STD	SFEM256GB2ED1TB-A-VG-111-STD		

ATS 2 (Assembly Test Site 2)

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1.1 System Performance

Gen3 Flash				
System Performance, HS400	Max. 3D TLC Max. reliable mode		Unit	
Burst Data transfer Rate HS400 (max clock 200MHz)	40			
Sequential Read	up to 320 up to 320		MB/s	
Sequential Write	up to 240	up to 240		

Gen5 Flash				
System Performance, HS400	Max. 3D TLC Max. reliable mode		Unit	
Burst Data transfer Rate HS400 (max clock 200MHz)	40			
Sequential Read	up to 320	MB/s		
Sequential Write	up to 240	up to 240		

1.2 Current consumption

Gen3 Flash					
Current Consumption, HS400, Max. Density	Typ. ICCQ current @ VCCQ 1.8V	Typ. ICC current @ VCC 3.3V	Unit		
Write	102	101			
Read	153	102	mA		
Sleep	0.07	0.07			

Gen5 Flash				
Current Consumption, HS400, Max. Density	Typ. ICCQ current @ VCCQ 1.8V	Typ. ICC current @ VCC 3.3V	Unit	
Write	102	101		
Read	153	102	mA	
Sleep	0.07	0.07		

1.3 Physical Dimensions

Physical Dimensions	Value	Unit
Length	13±0.1	
Width	11.5±0.1	mm
Thickness	1.2 max.	

1.4 Recommended Temperature Conditions

Parameter	Min.	Тур.	Max.	Unit
Industrial Operating / Storage Temperature	-40	25	85*	°C
Automotive Operating / Storage Temperature	-40	25	105*	°C

* High temperature storage without operation reduces the data retention, in operation the data will be refreshed, if data error issues were detected

For more information on e•MMC interface, please visit JEDEC homepage (www.jedec.org)

Why Swissbit?

Swissbit is focused on the design, development, manufacture, and support of leading edge memory and storage solutions for the worldwide OEM/ODM marketplace. As a global supplier, Swissbit recognizes and addressees the higher level of application requirements of today's industrial, Netcom, and automotive customers by providing best-in-class products and services, with uncompromised attention to driving overall value and quality.

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